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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

application of:

Yoshifumi KOJIMA et al

Serial No.: 10/537918

Filed: June 8, 2005

For: THERMOPLASTIC ELASTOMER, GASKET,  
MOLDED GASKET AND SEALING STRUCTURE  
BETWEEN TWO MEMBERS

**INFORMATION DISCLOSURE STATEMENT**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

As a means of complying with the duty of disclosure under 37 CFR §1.56, and in accordance with 37 CFR §§1.97 and 1.98, Applicant(s), through the undersigned attorney, submits this Information Disclosure Statement. The patents, publications or other information submitted herewith are listed on the attached Form PTO-1449 and copies are attached excluding U.S. patents and publications.

The documents listed on the attached Form PTO-1449 were cited in the International Search Report. A copy of the ISR is attached.

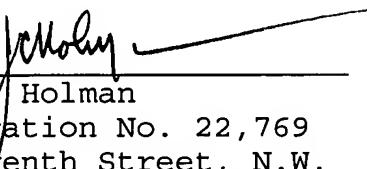
In accordance with 37 CFR §1.97(b)(1) or (2), this Information Disclosure Statement is being filed either within three months of the filing date of the above-identified application, or within

three months of the date of entry into the national stage of the above-identified application as set forth in 37 CFR §1.491. Accordingly, no fee is required.

Respectfully submitted,

JACOBSON HOLMAN PLLC

By:

  
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Atty. Dkt. No.: P70630US0  
Date: September 6, 2005

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400 SEVENTH STREET, N.W.  
WASHINGTON, D.C. 20004-2201

Sheet 1 of 1

## LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT

ATTY. DOCKET NO.: P70630US0  
SERIAL NO.: 10/537918  
APPLICANT(S) : KOJIMA et al

GROUP ART UNIT: \_\_\_\_\_  
FILING DATE: June 8, 2005  
TODAY'S DATE: September 6, 2005

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U.S. PATENT DOCUMENTS

*EXAMINER <u>INITIAL</u>	DOCUMENT <u>NUMBER</u>	DATE	NAME	SUB- <u>CLASS</u>	FILING DATE <u>CLASS</u> <u>If Appropriate)</u>
AA	_____	_____	_____	_____	_____
AB	_____	_____	_____	_____	_____

\*\*\*\*\*  
FOREIGN PATENT DOCUMENTS

	DOCUMENT <u>NUMBER</u>	DATE	COUNTRY	SUB- <u>CLASS</u>	TRANSLATION <u>YES</u> <u>(NO)</u>
AC	<u>1031608A2</u>	<u>08/30/00</u>	<u>Europe</u>	_____	_____
AD	<u>2000-344987</u>	<u>12/12/00</u>	<u>Japan</u>	_____	<u>Abstract</u>
AE	<u>2001-280507</u>	<u>10/10/01</u>	<u>Japan</u>	_____	<u>Abstract</u>
AF	<u>2001-280508</u>	<u>10/10/01</u>	<u>Japan</u>	_____	<u>Abstract</u>
AG	<u>2003-080555</u>	<u>03/19/03</u>	<u>Japan</u>	_____	<u>Abstract</u>
AH	<u>2003-096257</u>	<u>04/03/03</u>	<u>Japan</u>	_____	<u>Abstract</u>
AI	<u>2003-173671</u>	<u>06/20/03</u>	<u>Japan</u>	_____	<u>Abstract</u>

\*\*\*\*\*  
OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

AJ	_____
AK	_____
AL	_____

EXAMINER	DATE CONSIDERED
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\* EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant(s)